

Siemens Polydoros 50SX/80SX X-ray Controls Maintenance Course

Course length: 1 Week
CEU's Awarded: 4

<p>COURSE INTRODUCTION The Siemens Polydoros course is designed to teach the experienced service professional those skills necessary to fully service this x-ray control. This includes complete calibration procedures, functional checks, troubleshooting and Siemens documentation interpretation. The course consists of integrated lecture, labs and documentation which complement each other ensuring the maximum learning environment.</p>	<p>COURSE OBJECTIVES At the conclusion of this course, attendees will be able to:</p> <ul style="list-style-type: none"> ● Troubleshoot to the component or board level. ● Calibrate all circuitry to the manufacturer's specification. ● Perform all related CDRH compliance testing. ● Verify the system performance. 	<p>PREREQUISITES FOR ADMISSION Attendees must possess the knowledge acquired through attendance at our Advanced Concepts of Radiographic Imaging Maintenance-Level II course or the equivalent electronics and service experience. A strong microprocessor background is recommended.</p>
<p>DAY 1</p> <ol style="list-style-type: none"> I. Introduction <ol style="list-style-type: none"> A. High frequency concepts B. Falling load concepts C. Basic operation D. System specifications E. Option packages II. Siemens documentation <ol style="list-style-type: none"> A. Terminology/symbology B. Equipment layout C. Control panel D. Service board E. Functional diagrams F. Schematics III. Console operation <ol style="list-style-type: none"> A. Knobology B. Anatomical programming C. Zero point techniques IV. System block diagram V. Intermediate circuit VI. Power supplies VII. Power up sequence <p>LAB ACTIVITIES</p> <ol style="list-style-type: none"> I. System operation II. Physical layout <ol style="list-style-type: none"> A. Control console B. Power cabinet III. Component location IV. Power supply checks/adjustments V. APR Programming VI. Troubleshooting 	<p>DAY 2</p> <ol style="list-style-type: none"> I. KV logic diagram <ol style="list-style-type: none"> A. KV selection circuits B. KV inverter drive circuits C. KV feedback D. Min/Max monitoring E. Inverter short detection/ protection circuits F. Load compensation circuits G. Fluoro KV control <p>LAB ACTIVITIES</p> <ol style="list-style-type: none"> I. KV circuits component location II. KV circuits waveform analysis III. KV waveform analysis IV. Troubleshooting <p>DAY 3</p> <ol style="list-style-type: none"> I. Filament control logic diagram <ol style="list-style-type: none"> A. mA selection circuits B. Filament inverter drive circuits C. Filament feedback circuits D. Actual value detection circuits E. Filament safety circuits II. Rotor control logic diagram <ol style="list-style-type: none"> A. Rotor inverter drive circuits B. Start to run circuits C. Current sensing circuits D. Brake circuits <p>LAB ACTIVITIES</p> <ol style="list-style-type: none"> I. Filament control component location II. Filament control calibration 	<ol style="list-style-type: none"> A. Preheating B. Learning filament correction C. Push values III. Filament control waveform analysis IV. Rotor control programming V. Anode speed verification VI. Rotor control waveform analysis VII. Troubleshooting <p>DAY 4</p> <ol style="list-style-type: none"> I. Iontomat P logic diagram <ol style="list-style-type: none"> A. Ion chamber B. KV correction C. Density Correction II. KK interface logic diagram <ol style="list-style-type: none"> A. Unit selection B. Fluoro / tomo C. Spotfilmer D. Imaging III. Control logic <ol style="list-style-type: none"> A. MPS bus communication B. SMP bus communication C. Prep/expose logic <p>LAB ACTIVITIES</p> <ol style="list-style-type: none"> I. AEC component locations II. AEC waveform analysis III. KV correction calibration IV. Density correction calibration V. Troubleshooting <p>DAY 5</p> <ol style="list-style-type: none"> I. Final exam II. Exam review III. Course critique IV. Parts sourcing